

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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PARTING   COLTAGE   SO \ CTO 85 °C   TO 85		(50)	128-0.	   天:	PART NO.	SHEE	SPE	万 万
STANDER ANGE		ì						
100		16-01	ELC4-32674	ING NO.	DRAW	surance Test X:Applicable Test		Note QT:
DESCRIPTION OF REVISIONS   DESCRIPTION OF REVISIONS   DESCRIPTION OF REPORT	. 10. 19	09.	TS. 00N0	DRAWN		0	therwise specified, n	Jnless c
100 CTO 50 C	. 10. 19	09.		DESIGNED		ant.	duct is RoHS compli	This pro
SEPANDER   SO V AC / DC	10. 20	09.	FN. TAMURA	CHECKED				
DESCRIPTION OF REVISIONS   DESCRIPTION OF REVISION OF PARTS.   DESCRIPTION OF RESISTANCE: 100 mm   DESCRIPTION OF REVISION OF PARTS.   DESCRIPTION OF REVISION OF PARTS.   DESCRIPTION OF RESISTANCE: 100 mm   DESCRIPTION OF REVISIONS   DESCRIPTION OF RESISTANCE: 100 mm   DESCRIPTION OF RESISTANCE: 100 mm   DESCRIPTION OF REVISIONS   DESCRIPTION OF REVISIONS   DESCRIPTION OF RESISTANCE: 100 mm   DESCRIPTION OF REASON   DESCRIPTION OF RESISTANCE: 100 mm   DESCRIPTION OF RESISTA	. 10. 20	09.		APPROVED				REMARK
STORMER   SO V AC / DC	DATE	- - -	CHECKED		DESIGNED			
CTION		<del> </del>	RACK AND LOOSENESS	NSULATION RE (AT DRY) NO DAMAGE, CI DF PARTS.	(A) (G)		-	
SIDNATURE RANGE   -55 °C TO 85 °C   SIDNATURE RANGE   -10 °CTO 50 °C		•	STANCE: 100 mΩ MAX SISTANCE: 1 MΩ MIN HUMIDITY)	CONTACT RESI:  NSULATION RE  (AT HIGH F	© (1)	ED AT -10 TO +65 °C, IVE HUMIDITY 90 TO 96 %, LES,TOTAL 240 h.	1 E	DAMP HE,
TEMPERATURE RANGE   -55 °C TO 85 °C   TO 85 °C   TEMPERATURE RANGE   -10 °C TO 50 °C   TEMPERATOR RANGE   TEMPERATOR RESISTANCE: 100 mg   FARTS   FOR 10 °C TO 50 °C   TEMPERATOR RANGE   TEMPERATOR RESISTANCE: 100 mg   FARTS   FOR 10 °C TO 50 °C   TEMPERATOR RESISTANCE: 100 mg   FARTS   FOR 10 °C TO 55 Hz. HALF AMPLITUDE   JS TO DEARTHOLOUS				OF PARTS.	0	95 %, 96		STEADY :
DUTAGE  DUTAGE  DUTAGE  DURRENT  DO, 5 A  TEST METHOD  TEST METHOD  TEST METHOD  TEST METHOD  TEST METHOD  TO CORDING TO DRAWING.  CONFIRMED VISUALLY.  CONFIRMED VISUALLY.  CONFIRMED VISUALLY.  CONFIRMED VISUALLY.  TO V DC.  100 V		0) (	100 m E: 50 Ms D LOOS	CONTACT RESI: NSULATION RE NO DAMAGE, CI	<u>ω</u> ω ⊖	RATURE-55 $\rightarrow$ +15 $_{10}$ +35 $\rightarrow$ +85 $\rightarrow$ +15 $_{10}$ 30 $\rightarrow$ 2 $_{10}$ 3 $\rightarrow$ 30 $\rightarrow$ 2 $_{10}$ 5 CYCLES.	OF	RAPID CH FEMPERA
DUTAGE			OF CORROSION WHICH PERATION OF	NO EVIDENCE OFFECTS TO OFSONNECTOR.	(a) A Z (d)			
STORAGE   STORAGE   CONTACTER RANGE   CONTACTE RESISTANCE   CONTACTE RECONTACTS METHOD   CONTACT RESISTANCE   CONTACT RESISTANCE   CONTACT RESISTANCE   CONTACTS METHOD   CONTACT RESISTANCE   CONTACTS METHOD   CONTACT RESISTANCE   CONTACTS METHOD   CONTACT RESISTANCE   CONTACTS METHOD   CONTACTS METHOD   CONTACT RESISTANCE   CONTACTS METHOD   CONTACTS METHOD   CONTACTS METHOD   CONTACT RESISTANCE   CONTACTS METHOD   CONTACTS METHOD   CONTACTS METHOD   CONTACT RESISTANCE   CONTACTS METHOD   CONTACT RESISTANCE   CONTACTS METHOD   CONTACT RESISTANCE   CONTACT RESISTANCE   CONTACTS METHOD   CONTACT RESISTANCE   CONTACT RESISTANCE   CONTACTS METHOD   CONTACT RESISTANCE   CONTA			STANCE: 100 mΩ MAX RACK AND LOOSENES	CONTACT RESI NO DAMAGE, CI	<b>⊘</b> ⊝	°C ,5%		CORROSI
A-BRAINGE   -55 °C TO 85 °C   TO MEMORIA   TO STORAGE						ACTERISTICS		<b>ENVIR</b> C
PERATURE PANGE  -55 °C TO 85 °C  TEMPERATURE RANGE  DUTAGE  50 V AC / DC  HUMDITY RANGE  CHARACTERISTICS  FREQUENCY 10 TO 55 Hz, HALF AMPLITUDE  0.5 A  TEST METHOD  TO FLASHOVER OR BREAKDOWN.  TOO MΩ MIN.  TOO MΩ MAX.  TOO MΩ		×	≤	IRECTION OF IT 3N × NUMBER ( note 1)		RED BY APPLICABLE FPC. VESS OF FPC SHALL BE t=0.30mm AL CONDITION.)		PC RETE
COLPRAILING			100 m D LOOS	CONTACT RESI NO DAMAGE, C DF PARTS.	2	S INSERTIONS AND EXTRACTIONS		MECHANII OPERATIO
TING	<u> </u>		100 m D LOOS	CONTACT RESI NO DAMAGE, C DF PARTS.	<u>@</u> 2	, DURATION OF PULSE 6 ms MES IN 3 DIRECTIONS.		SHOCK
TING RATURE RANGE RATURE RANGE RATURE RANGE ROUN  INCE RATURE RANGE RETURE RANGE RECTO 50 °C REMPERATURE RANGE RELATIVE HUMIDITY PAYAGE RELATIVE HUMIDITY 9 APPLICABLE CABLE RELATIVE HUMIDITY 9 APP		×		NO ELECTRICA	$\Theta$	ENCY 10 TO 55 Hz, HALF AMPLITUE ), FOR 10 CYCLES IN 3 DIRECTION:		/IBRATIO
SI ORAGE   -55 °C TO 85 °C   TEMPERATURE RANGE   -10 °C TO 50 °C   TEMPERATURE RANGE   CORPANCE   CONFIRMED VISUALLY AND BY MEASURING INSTRUMENT.   CONFIRMED VISUALLY.   TEST METHOD	}	$\mid$				ERISTICS	CHA	MECHA
SI ORAGE   -55 °C TO 85 °C   TEMPERATURE RANGE   -10 °C TO 50 °C   TEMPERATURE RANGE   -10 °C TO 50 °C   TEMPERATURE RANGE   -10 °C TO 50 °C   GERATING OR STORAGE   FLATIVE HUMIDITY 9   -10.3 ± 0.03 mm, STORAGE   -10 °C TO 50 °C   GERATING INSTRUMENT   ACCORDING TO DRAWING.   CONFIRMED VISUALLY AND BY MEASURING INSTRUMENT.   ACCORDING TO DRAWING.   CONFIRMED VISUALLY   ACCORDING TO DRAWING.   CONFIRMED VISUALLY   ACCORDING TO DRAWING.   SO MΩ MIN.   SO		×	FC BULK RESISTANCE	mΩ MAX. LUDING FPC,FF ŷmm)	100 INCI (L=8	20 mV MAX ( AC:1 KHz ) , 1 mA .		CONTACT
TEMPERATURE RANGE TEMPERATURE		×		MΩ MIN.	500	C.		NSULATIO RESISTAN
TEMPERATURE RANGE TEST METHOD TEST M		×	R BREAKDOWN.	FLASHOVER O	NO	C FOR 1 min.		OLTAGE
TEMPERATURE RANGE  -55 °C TO 85 °C  TEMPERATURE RANGE  -10 °CTO 50 °C  TEMPERATURE RANGE  TEMPERATURE RANGE  OPERATURE RANGE  FELATIVE HUMIDITY PAVE  RELATIVE HUMIDITY PAVE  RELATIVE HUMIDITY PAVE  RELATIVE HUMIDITY PAVE  RELATIVE HUMIDITY PAVE  REQUIREMENTS  RUCTION  TEST METHOD  TEST METHOD  REQUIREMENTS  REQUIREMENTS  REQUIREMENTS  REQUIREMENTS  REQUIREMENTS	$\vdash$	×				STICS	$\sim$	T FOT
FIGURE RANGE -55 °C TO 85 °C T	+	×	RAWING.			LY AND BY MEASURING INSTRUME		GENERAL
TEMPERATURE RANGE  -55 °C TO 85 °C  TEMPERATURE RANGE  RELATIVE HUMIDITY 9  TEMPERATURE RANGE  TEMPERATURE RANGE  RELATIVE HUMIDITY 9  TEMPERATURE RANGE  RELATIVE HUMIDITY 9  TEMPERATURE RANGE  TEMPERATURE RANGE  RELATIVE HUMIDITY 9  TEMPERATURE RANGE  TEMPERATURE RANGE  RELATIVE HUMIDITY 9  TEMPERATURE RANGE  RELATIVE HUMIDITY 9  TEMPERATURE RANGE  TEMPERATURE RANGE  RELATIVE HUMIDITY 9  TEMPERATURE RANGE  RELATIVE HUMIDITY 9  TEMPERATURE RANGE  TEMPERATURE RANGE  TEMPERATURE RANGE  RELATIVE HUMIDITY 9  TEMPERATURE RANGE  TEMPERATURE RANGE  TEMPERATURE RANGE  TEMPERATURE RANGE  RELATIVE HUMIDITY 9  TEMPERATURE RANGE	-	QI	UIREMENTS	REQI		TEST METHOD	RUCTION	CONST
TEMPERATURE RANGE -55 °C TO 85 °C TEMPERATURE RANGE -10 °C TO 50 °C TEMPERATURE RANGE PLATIVE RANGE PLATIVE HUMIDITY 9  CURRENT 0.5 A APPLICABLE CABLE t=0.3 ±0.03mm,	1				I≫	CIFIC	_	
TEMPERATURE RANGE -55 °C TO 85 °C TEMPERATURE RANGE -10 °C TO 50 °C TEMPERATURE RANGE PLATIVE HUMIDITY 9	ĪNG	) PLATI	1-	LE CABLE	APPLICABI	0.5 A	CURRENT	
-55 °C TO 85 °C SIORAGE TEMPERATURE RANGE -10 °C TO 50 °C	DEWEC	AX (NOT [	RELATIVE HUMIDITY 90 % M	STORAGE	OPERATING HUMIDITY RAI	V AC/	VOLTAGE	RATING
	NOLLO	ED CONI		TURE RANGE	TEMPERAT	°C TO 85	TEMPERATURE RANGE	

HIROSE ELECTRIC CO., LTD.

CODE NO.

CL580-1233-3-50

_				
			TMP 350 ± 10 °C FOR 5±1 sec .	
			2) SOLDERING IRONS :	
		TERMINALS.	REFLOW TMP. OVER 230 °C WITHIN 60 sec.	
		EXCESSIVE LOOSENESS OF THE	PEAK TMP. 250 °C MAX .	SOLDERING HEAT
	×	NO DEFORMATION OF CASE OF	1) REFLOW SOLDERING :	RESISTANCE TO
		THE SURFACE BEING IMMERSED.	2±0.5 sec.	
		SHALL COVER A MINIMUM OF 95 % OF	235±5°C FOR IMMERSION DURATION,	
	×	A NEW UNIFORM COATING OF SOLDER	SOLDERED AT SOLDER TEMPERATURE,	SOLDERABILITY
		CONNECTOR.	10 TO 15 ppm FOR 96 h.	
		AFFECTS TO OPERATION OF	[JIS C 0092] RELATIVE HUMIDITY 80±5%,	[JIS C 0092]
I	×	③ NO EVIDENCE OF CORROSION WHICH	EXPOSED AT 40±2 °C ,	HYDROGEN SULPHIDE
		OF PARTS.	25±5 ppm FOR 96 h.	
		② NO DAMAGE, CRACK AND LOOSENESS	[JIS C 0090] RELATIVE HUMIDITY 80±5%	[JIS C 0090]
I	×	① CONTACT RESISTANCE: 100 mΩ MAX.	EXPOSED AT 40±2 °C ,	SURPHUR DIOXIDE
I	×	OF PARTS.	EXPOSED AT -55±3°C, 96 h.	COLD
		1/② NO DAMAGE, CRACK AND LOOSENESS		
1	×	① CONTACT RESISTANCE: 100 mΩ MAX.	EXPOSED AT 85±2 °C, 96 h.	DRY HEAT
AT	ଧ୍	REQUIREMENTS	TEST METHOD	MƏTI
		NS	SPECIFICATIONS	

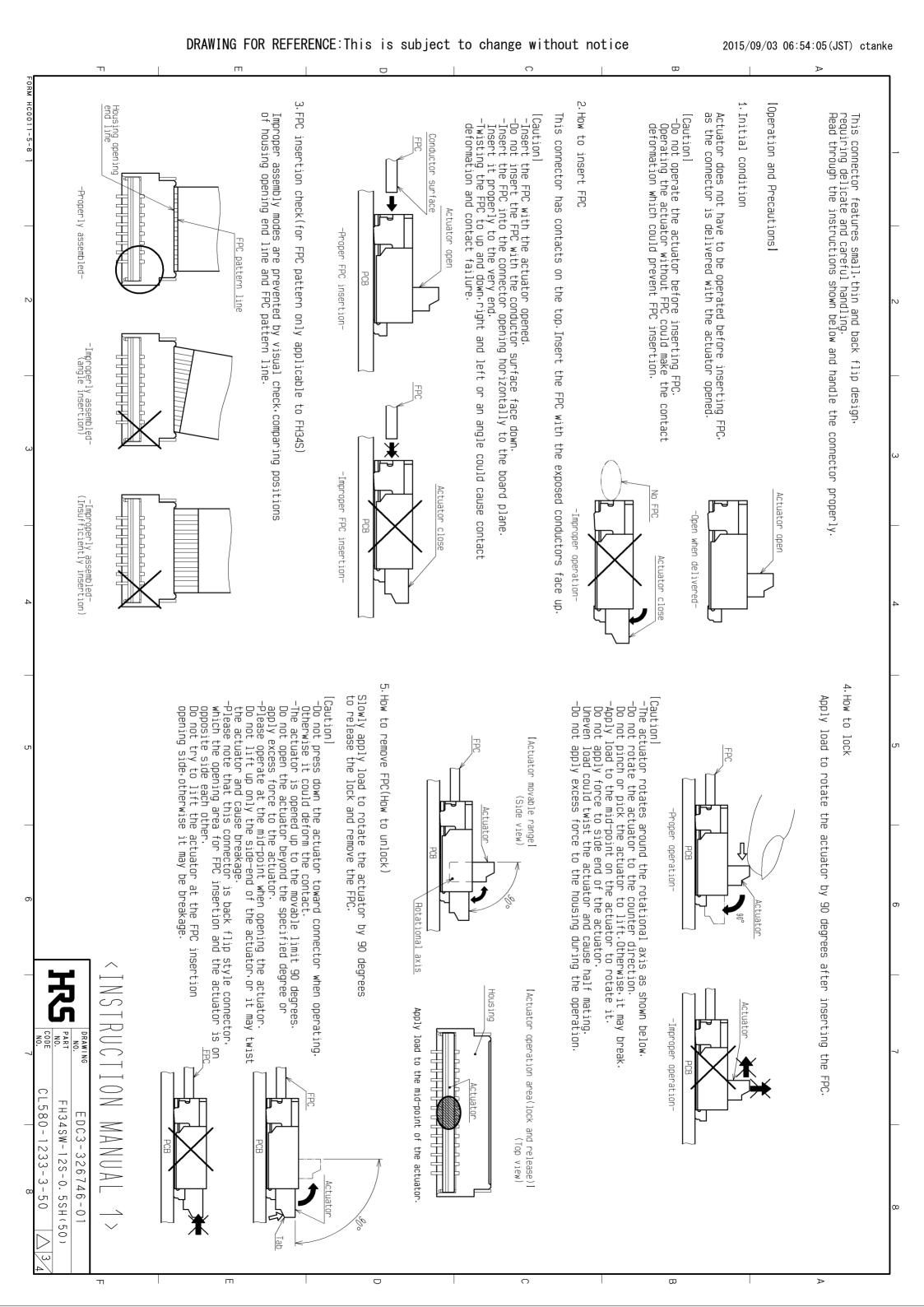
## 10101

FASTEN FPC ON PCB OR SOMETHING FIXED IF FORCE IN VERTICAL DIRECTION SHALL BE PREDICTED. ONTO A PCB. CLOSING THE ACTUATOR WITHOUT FPC COULD MAKE THE CONTACT GAP SMALLER, DO NOT CLOSE THE ACTUATOR BEFORE INSERTING FPC EVEN AFTER THE CONNECTOR IS MOUNTED

WHICH INCREASES THE FPC INSERTION FORCE.

THIS CONNECTOR HAS CONTACTS ON THE TOP.

HRS SPECIFICATION SHEET PART NO. FH34SW-12S-0. 5SH (50)
HIROSE ELECTRIC CO., LTD.   CODE NO   CL580-1233-3-50



This Read connector features small thin and back flip design requiring delicate a through the instructions shown below and handle the connector properly. and careful handling

lInstruction for mounting on the board|

♦Warp of board Minimize warp of the board as much as possible. Lead co-planarity including reinforced metal fittings is 0.1mm Too much warp of the board may result in a soldering failure.

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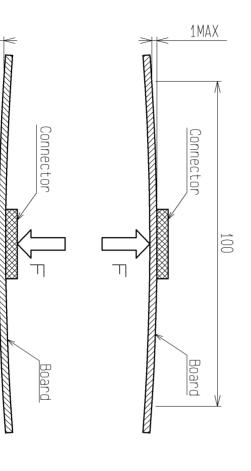
◆Load to connector
Do not apply mechanical stress to the connector
Otherwise the connector may be broken.
Do not insert the FPC or operate the connector t before mounting 9 the board.

bofore mounting

◆Load to board
-Splitting a large board into several pieces.
-Screwing the board
Avoid the handling described above so that no
during the assembly process.
Otherwise, the connector may become defective. force İS applied on the board

♦Amount of bend of board
The bend of a 100-mm wide board should be 1mm or less
The bend of board could apply stress on the connector as shown below. and it may bocc may bocome defective

♦Reflow temperature profile Apply reflow temperature profile within the specified conditions. In individual applications, the actual temperature may vary, depending on solder paste type volume/thickness and board size/thickness. Consult your solder paste and equipment manufacturer for specific recommendations.



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## Precautions for design

1.During FPC wiring, ensure that stress Do not bend the FPC excessively near contact failure or FPC breakage. Stabilizing the FPC is recommended. is not applied the connector ( directly to the connector during use or it may cause

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- 2.Keep a sufficient FPC insertion space in the stage of the layout in order to a incorrect FPC insertion.

  Appropriate FPC length and component layout are recommended for assembly ease. Too short FPC length makes assembly difficult. of the layout in order to avoid
- Follow the recommended PCB layout, FPC design and the metal mask opening design.
- 4. Make adjustments with the FPC manufacturer for FPC bending performance and wire breakage.
- Keep spaces for the actuator movement and its operation for PCB design and component layout.

Other instructions

- ♦Instructions on manual soldering Follow the instructions shown below when soldering
- the connector manually during repair work etc.
- 1.Do not perform manual soldering with the FPC inserted into the connector.
- 2.Do not heat the any parts other connector excessively. Be very caref than connector leads. Otherwise, the ful not to let the soldering iron contact connector may be deformed or melt.
- 3.Do not apply excessive solder(or flux).

  If excessive solder(or flux) is applied

Supplying excessive solder to the metal resulting in breakage of the connector. the actuator. contacts or rotating parts of s applied on the terminals, solder or flux may adhere to the the actuator, resulting in poor contact or a rotation failure of may hinder actuator rotation

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NSTRUCTION MANUAL 2>

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CODE	PART NO.	DRAWING NO.	
CL580 - 1233 - 3 - 50 $/ / / / /$	FH34SW-12S-0.5SH(50)	EDC3-326746-01	
			-